

# APG0603SEC-E-TT

0.65 x 0.35 x 0.2 mm SMD Chip LED Lamp



## DESCRIPTIONS

- The Hyper Red source color devices are made with AIGaInP on GaAs substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- · It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

## **FEATURES**

- 0.65 mm x 0.35 mm SMD LED. 0.2 mm thickness
- Low power consumption
- Wide viewing angle
- · Compatible with automatic placement equipment
- Package: 4000 pcs / reel
- Moisture sensitivity level: 2
- Halogen-free
- RoHS compliant

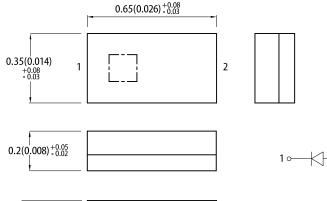
## APPLICATIONS

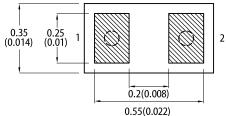
- Backlight
- Status indicator
- · Home and smart appliances
- Wearable and portable devices
- · Healthcare applications

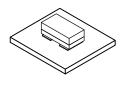
### ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices







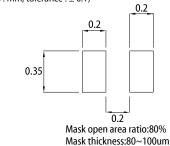


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#### **RECOMMENDED SOLDERING PATTERN**

PACKAGE DIMENSIONS

(units : mm; tolerance :  $\pm 0.1$ )



Notes

 All dimensions are in millimeters (inches).
Tolerance is ±0.1(0.004") unless otherwise noted.
The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The device has a single mounting surface. The device must be mounted according to the specifications.

## SELECTION GUIDE

Part Number	Emitting Color	Lens Type	Iv (mcd) @ 10mA [2]		Viewing Angle <sup>[1]</sup>	
Fait Nulliber	(Material)		Min.	Тур.	201/2	
APG0603SEC-E-TT	Hyper Red (AlGaInP)	Water Clear	45	120	140°	
			*15	*40	140	

Notes

Involus. 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity / luminous flux: +/-15%.

\* Luminous intensity value is traceable to CIE127-2007 standards.

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#### ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Parameter	Cumula al	Symbol Emitting Color Value Typ. Max.	Value		Unit
Parameter	Symbol		Max.		
Wavelength at Peak Emission $I_F$ = 10mA	$\lambda_{peak}$	Hyper Red	632	-	nm
Dominant Wavelength I <sub>F</sub> = 10mA	$\lambda_{dom}$ <sup>[1]</sup>	Hyper Red	624	-	nm
Spectral Bandwidth at 50% $\Phi$ REL MAX $I_F$ = 10mA	Δλ	Hyper Red	20	-	nm
Forward Voltage $I_F = 10mA$	V <sub>F</sub> <sup>[2]</sup>	Hyper Red	1.93	2.35	V
Reverse Current ( $V_R$ = 5V)	I <sub>R</sub>	Hyper Red	-	10	μA
Temperature Coefficient of $\lambda_{\text{peak}}$ $I_F$ = 10mA, -10°C $\leq T \leq 85^\circ C$	$TC_{\lambda peak}$	Hyper Red	0.13	-	nm/°C
Temperature Coefficient of $\lambda_{dom}$ $I_F$ = 10mA, -10°C $\leq T \leq 85°C$	TC <sub>λdom</sub>	Hyper Red	0.06	-	nm/°C
Temperature Coefficient of $~V_F$ $I_F$ = 10mA, -10°C $\leq$ T $\leq$ 85°C	TCv	Hyper Red	-1.9	-	mV/°C

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
Forward voltage: ±0.1V.
Wavelength value is traceable to CIE127-2007 standards.
Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

## ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

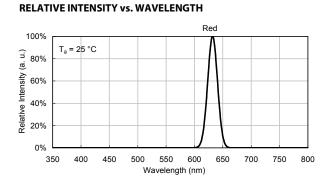
Parameter	Symbol	Value	Unit	
Power Dissipation	P <sub>D</sub>	48	mW	
Reverse Voltage	V <sub>R</sub>	5	V	
Junction Temperature	Tj	115	°C	
Operating Temperature	T <sub>op</sub>	-40 to +85	°C	
Storage Temperature	T <sub>stg</sub>	-40 to +85	°C	
DC Forward Current	I <sub>F</sub>	20	mA	
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	100	mA	
Electrostatic Discharge Threshold (HBM)	-	3000	V	
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> <sup>[2]</sup>	680	°C/W	
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	530	°C/W	

Notes: 1. /1/D Duty Cycle, 0.1ms Pulse Width. 2. R<sub>m, Ja</sub>, R<sub>h, JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

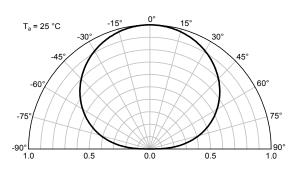
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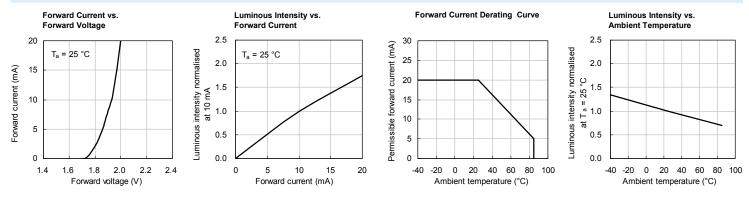
#### **TECHNICAL DATA**



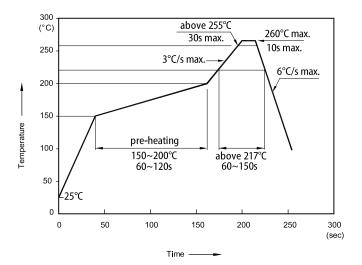
#### SPATIAL DISTRIBUTION



#### **HYPER RED**



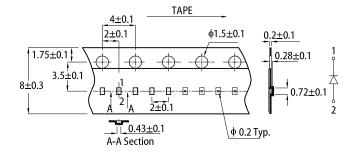
#### **REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS**



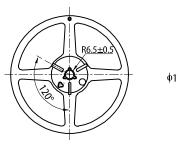
#### Notes:

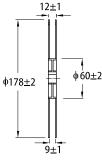
- Notes: 1. Don't cause stress to the LEDs while it is exposed to high temperature. 2. The maximum number of reflow soldering passes is 2 times. 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units:mm)



#### REEL DIMENSION (units : mm)

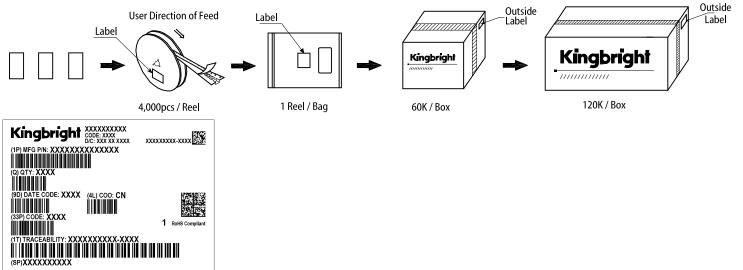




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#### **PACKING & LABEL SPECIFICATIONS**



#### **PRECAUTIONARY NOTES**

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications. 2.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening 3.
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